



Product Change Notification

Change Notification #: 119782-00

Change Title: Intel® Server System R1208WFQZSR, PCN 119782-00, Label, Product Material, Label update and adding alternate Hot Swap Backplane source

Date of Publication: December 07, 2023

Key Characteristics of the Change:

Label, Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:*	December 23, 2023
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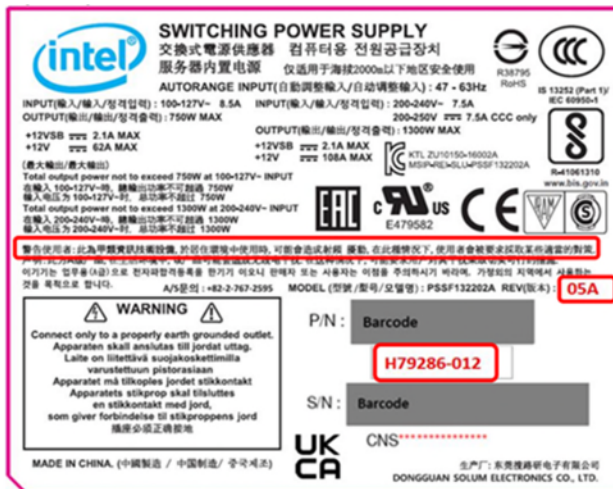
* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

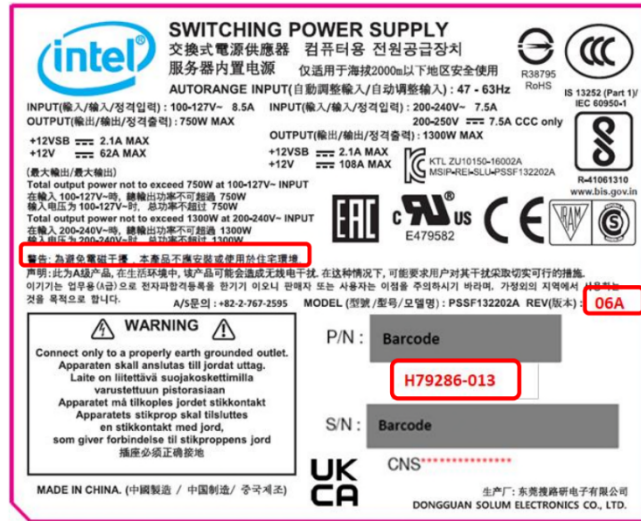
The Intel® SKU listed in the products affected table will have the following changes:

1. Addition of updated AXX1300TCRPS 1300W Power supply to the R1208WFQZSR SKU. The AXX1300TCRPS 1300W Power supply is changing from H79286-012 to H79286-013 due to a label update to incorporate the new Taiwan BSMI standards CNS15936 (CISPR32) and CNS15598-1 (IEC62368-1). The new BSMI standard has updated warning text that goes into effect January 1, 2024. Additional changes include a PSU firmware upgrade from 29.5.128 to 30.5.128 and a revision change from 05A to 06A. There is no impact to functionality.

Label-Before

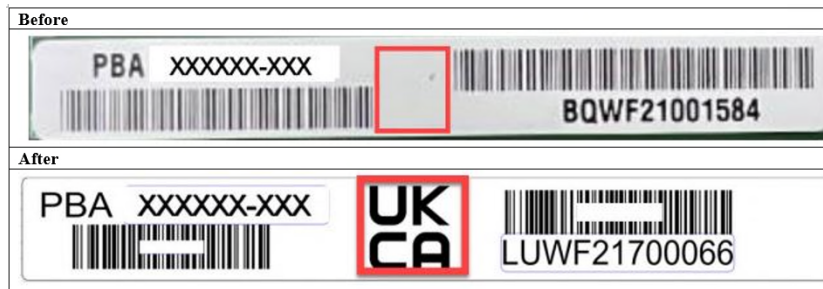


Label-After



2. Adding the UKCA logo to the Server Mother Board Serial Number Label

Mother Board PBA Revisions are updated from M71674-951, M71674-951, H87178-951, H87178-961 to M71674-952, M71674-952, H87178-952, H87178-962



3. Adding the following alternate Hotswap Backplane PBA: H88382-501.

This alternate HSBP PBA includes the second source for the Voltage Regulator (VR) controller and the interposer PCB supporting a new Programmable System-On Chip (PSOC). For business continuity, demand fulfillment, and to minimize customer impact, an interposer PCB supporting the new component was used. The new component has passed all functional and electrical validation tests successfully.

As a result, product listed in the “Products Affected” table could be delivered to customers with any of the PBA codes of the hot swap backplanes listed under "Post Change PBA" in the table.

Hotswap Backplane PBA Revisions are updated from H88382-351, H88382-352, H88382-401, H88382-411 to H88382-351, H88382-352, H88382-401, H88382-411, H88382-501

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® Server System R1208WFQZSR	R1208WFQZSR	99AW7H	M64557-002	M71674-951 H87178-951 H87178-961 H88382-351 H88382-352 H88382-401	M64557-003	M71674-952 H87178-952 H87178-962 H88382-351 H88382-352 H88382-401 H88382-411 H88382-501

PCN Revision History:

Date of Revision:

December 07, 2023

Revision Number:

00

Reason:

Originally Published PCN



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No response from customers will be deemed an acceptance of the change, and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below.

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